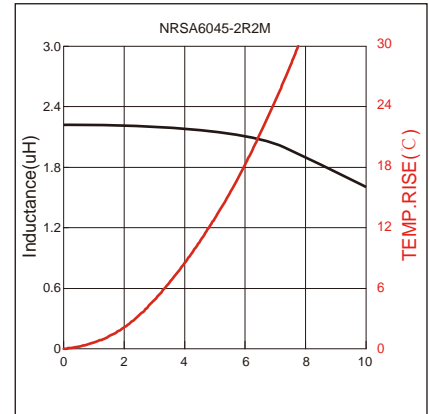
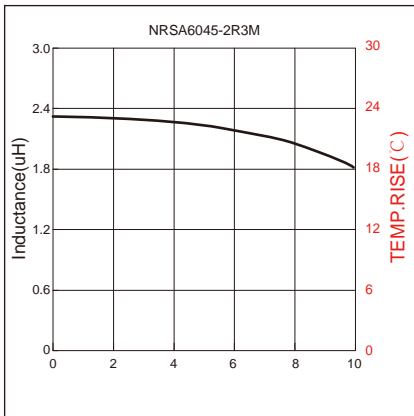
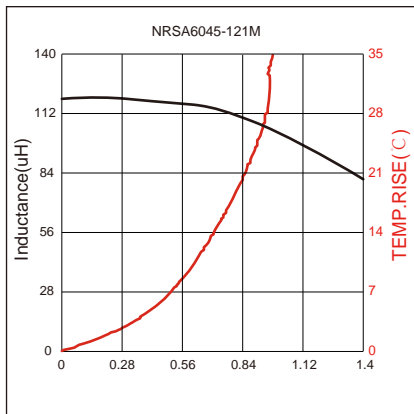
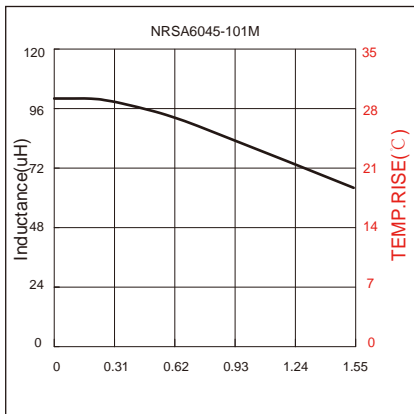
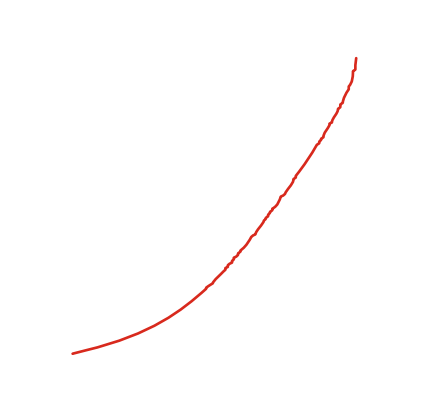
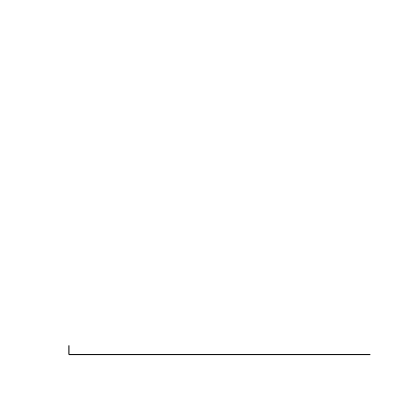
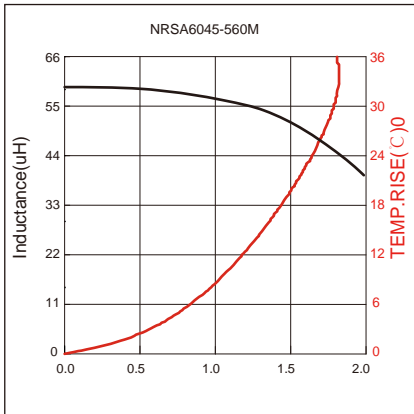
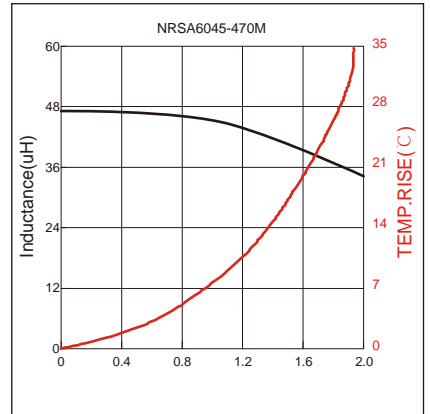
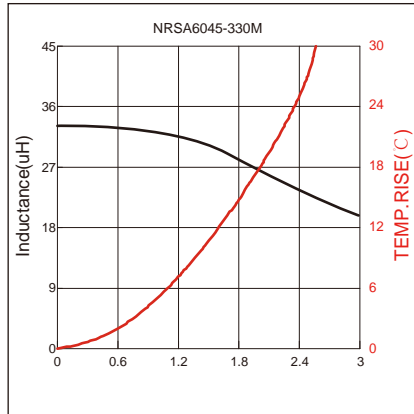
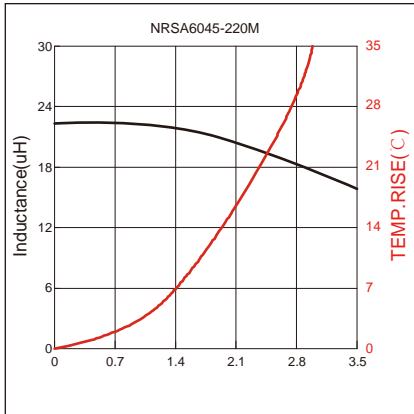
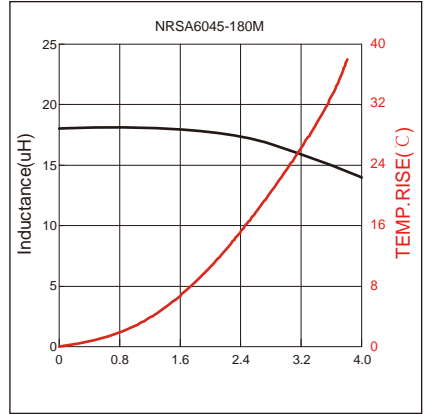
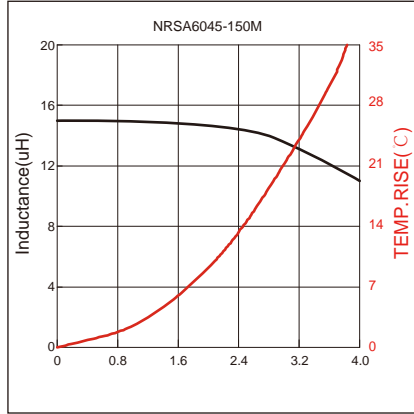
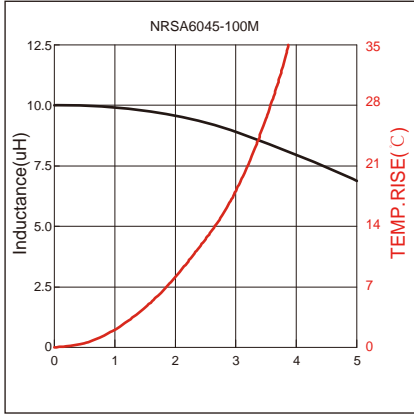


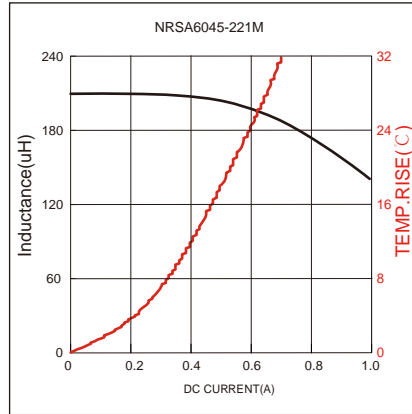
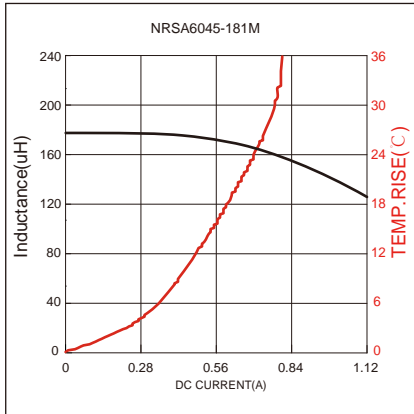



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Typical Electrical Characteristics:







## Soldering Reflow:

Preheat condition: 150 ~200°C / 60~120 sec.

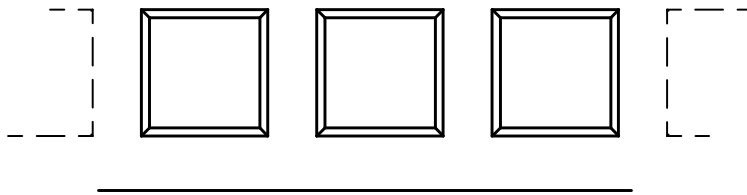
Allowed time above 217°C: 60~90 sec.

Max temperature: 260°C.

Allowed Reflow time: 2x max.

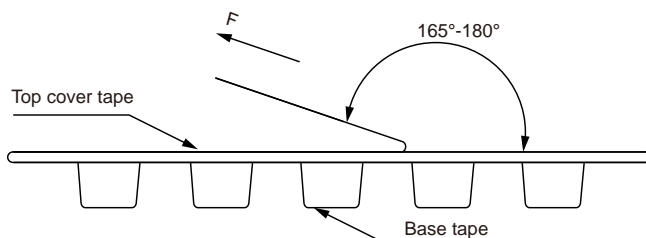
## Packaging Information:

Tape Dimension:



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
NRSA6045	6.4±0.1	6.4±0.1	1.5±0.1	4.0±0.1	12.0±0.1	16.0±0.3	4.7±0.1	1.75±0.1	0.40±0.05

Peel force of top cover tape:



The peel force of top cover tape shall be between 0.3 to 1.17 N

